

# LINEAR INTEGRATED CIRCUIT



## 10W AUDIO POWER AMPLIFIER

The TCA 940N is a monolithic integrated circuit in a 12-lead quad in-line plastic package, intended for use as a low frequency class B amplifier. The TCA 940N provides 10W output power @ 20V/4Ω, 7W @ 16V/4Ω and 6.5W @ 20V/8Ω. It gives high output current (up to 3A), very low harmonic and cross-over distortion. Besides the thermal shut-down, the device contains a current limiting circuit which restricts the operation within the safe operating area of the power transistors. The TCA 940N is pin to pin equivalent to the TBA 810 AS.

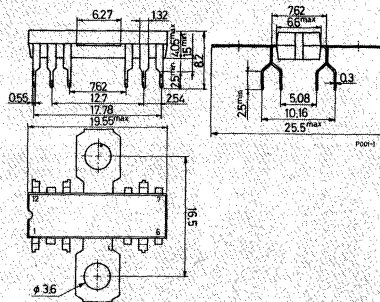
### ABSOLUTE MAXIMUM RATINGS

$V_s$	Supply voltage	28	V
$I_o$	Output peak current (non-repetitive)	3.5	A
$I_o$	Output peak current (repetitive)	3	A
$P_{tot}$	Power dissipation: at $T_{amb} = 50^\circ\text{C}$	1.25	W
	at $T_{tab} = 70^\circ\text{C}$	8	W
$T_{stg}, T_j$	Storage and junction temperature	-40 to 150	$^\circ\text{C}$

ORDERING NUMBER: TCA 940N

### MECHANICAL DATA

Dimensions in mm

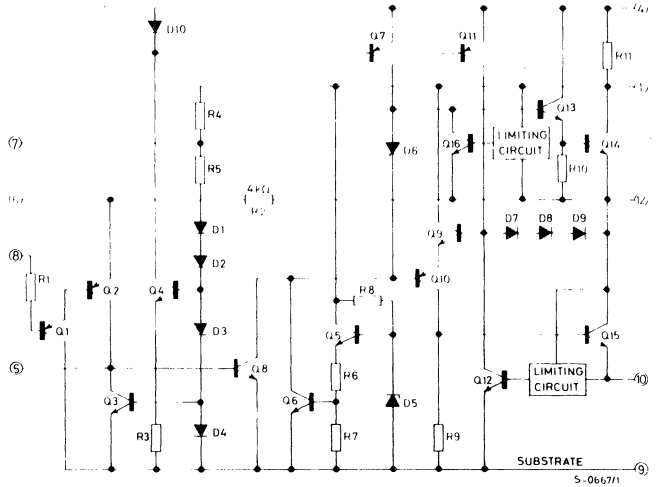
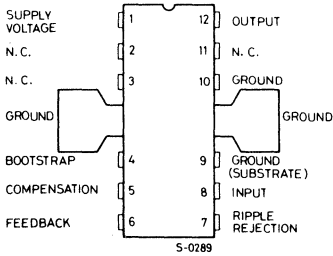




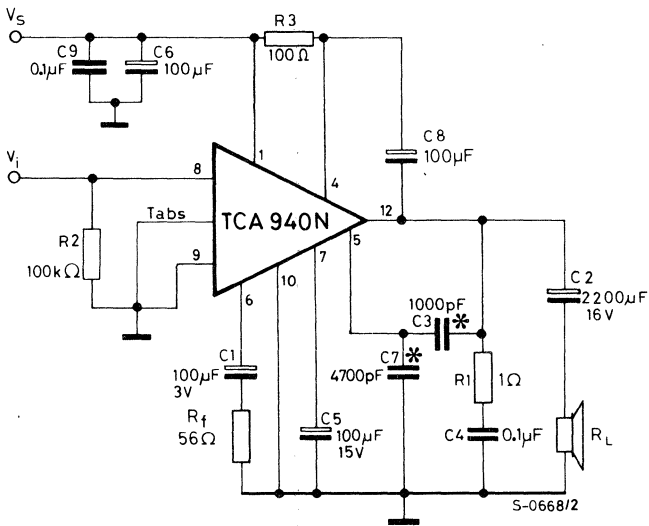
# TCA 940N

## CONNECTION AND SCHEMATIC DIAGRAMS

(top view)



## TEST AND APPLICATION CIRCUIT



\*=C3, C7 SEE FIG. 7



TCA940N

**THERMAL DATA**

$R_{th\ j-tab}$	Thermal resistance junction-tab	max	10	°C/W
$R_{th\ j-amb}$	Thermal resistance junction-ambient	max	80	°C/W

**ELECTRICAL CHARACTERISTICS** (Refer to the test circuit,  $T_{amb} = 25^{\circ}C$ )

Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_s$ Supply voltage (pin 1)		6		28	V
$V_o$ Quiescent output voltage (pin 12)	$V_s = 18V$	8.2	9	9.8	V
$I_d$ Quiescent drain current	$V_s = 12V$ $V_s = 24V$		13 20		mA mA
$I_b$ Input bias current (pin 8)	$V_s = 18V$		0.5		$\mu A$
$P_o$ Output power	$d = 10\%$ $f = 1\ kHz$ $V_s = 20V$ $R_L = 4\ \Omega$ $V_s = 18V$ $R_L = 4\ \Omega$ $V_s = 16V$ $R_L = 4\ \Omega$ $V_s = 20V$ $R_L = 8\ \Omega$ $V_s = 18V$ $R_L = 8\ \Omega$	7	10 9 7 6.5 5		W W W W W
$V_{i(rms)}$ Voltage for input saturation		250			mV
$V_i$ Input sensitivity	$P_o = 9W$ $V_s = 18V$ $R_L = 4\ \Omega$ $f = 1\ kHz$		90		mV
B Frequency response (-3 dB)	$V_s = 18V$ $R_L = 4\ \Omega$ $C_3 = 1000\ \mu F$	40 Hz to 20 KHz			
d Distortion	$P_o = 50\ mW$ to 5W $V_s = 18V$ $R_L = 4\ \Omega$ $f = 1\ kHz$		0.3		%
$R_i$ Input resistance (pin 8)			5		M $\Omega$
$G_v$ Voltage gain (open loop)	$V_s = 18V$ $R_L = 4\ \Omega$ $f = 1\ kHz$		75		dB
$G_v$ Voltage gain (closed loop)	$V_s = 18V$ $R_L = 4\ \Omega$ $f = 1\ kHz$	34	37	40	dB
$e_N$ Input noise voltage	$V_s = 18V$ $R_g = 0$		3		$\mu V$
$i_N$ Input noise current	$V_s = 18V$		0.15		nA



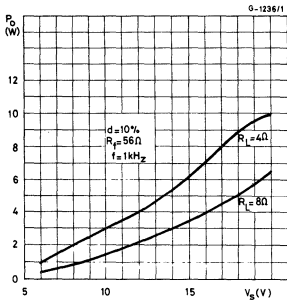
**TCA940N**

**ELECTRICAL CHARACTERISTICS (continued)**

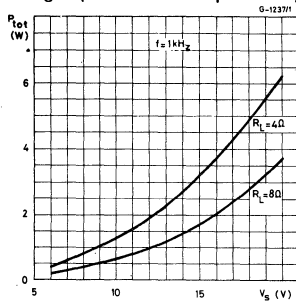
Parameter	Test conditions	Min.	Typ.	Max.	Unit
$\eta$ Efficiency	$P_O = 9W$ $V_S = 18V$ $R_L = 4\Omega$ $f = 1\text{ kHz}$		65		%
SVR Supply voltage rejection	$V_S = 24V$ $R_L = 4\Omega$ $f_{\text{ripple}} = 100\text{ Hz}$		45		dB
$I_d$ Drain current	$P_O = 9W$ $V_S = 18V$ $R_L = 4\Omega$		770		mA
$T_{sd}$ Thermal shut-down (*) Case temperature	$P_{\text{tot}} = 4.8W$		110		$^{\circ}C$

(\*) See fig. 15.

**Fig. 1 - Output power vs. supply voltage.**



**Fig. 2 - Maximum power dissipation vs. supply voltage (sine wave operation)**



**Fig. 3 - Distortion vs. output power.**

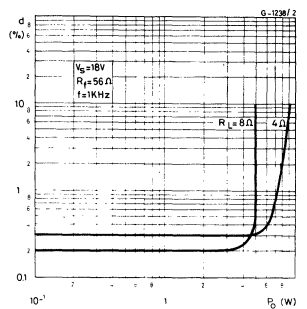


Fig. 4 - Voltage gain and input sensitivity vs. feedback resistance ( $R_f$ )

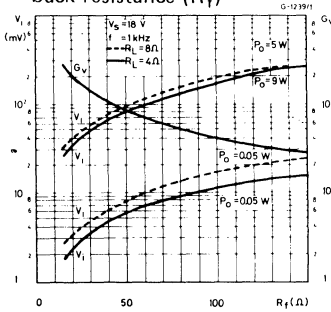


Fig. 5 - Distortion vs. frequency ( $R_L = 4\Omega$ )

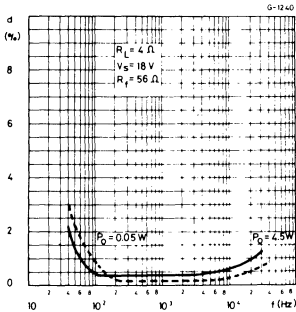


Fig. 6 - Distortion vs. frequency ( $R_L = 8\Omega$ )

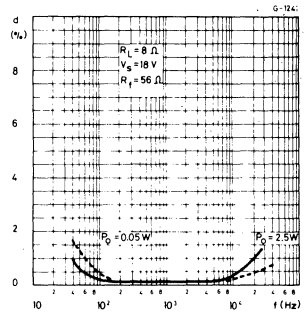


Fig. 7 - Value of C3 vs.  $R_f$  for different bandwidths

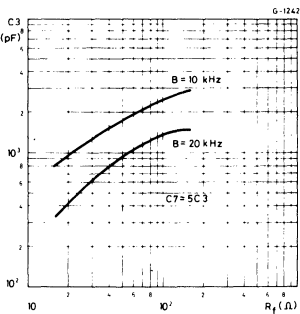


Fig. 8 - Supply voltage rejection vs. feedback resistance ( $R_f$ )

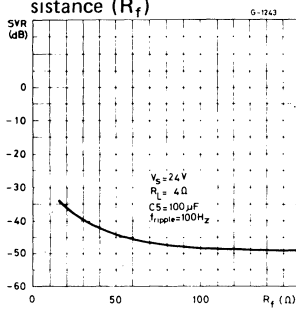


Fig. 9 - Power dissipation and efficiency vs. output power ( $R_L = 4\Omega$ )

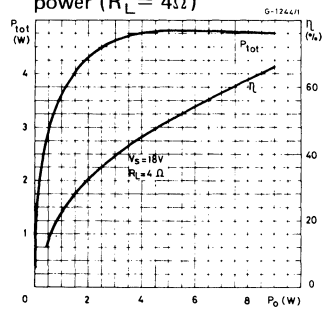


Fig. 10 - Power dissipation and efficiency vs. output power ( $R_L = 8\Omega$ )

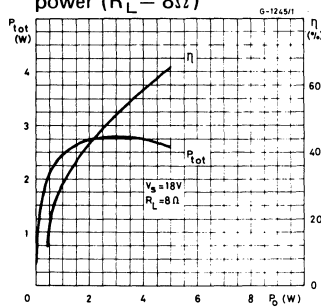


Fig. 11 - Quiescent output voltage (pin 12) vs. supply voltage

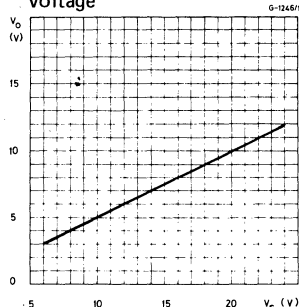
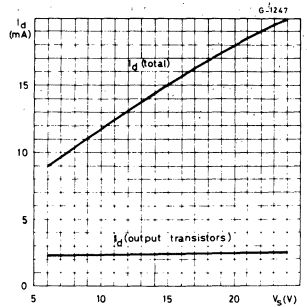


Fig. 12 - Quiescent current vs. supply voltage





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## SHORT CIRCUIT PROTECTION

The most important innovation in the TCA 940N is an original circuit which limits the current of the output transistors. Fig. 13 shows that the maximum output current is a function of the collector-emitter voltage; hence the circuit works within the safe operating area of the output power transistors. This can therefore be considered as being power limiting rather than simple current limiting. The TCA 940N is thus protected against temporary overloads or short circuit by the above circuit. Should the short circuit exist for a longer time, the thermal shut-down comes into action and keeps the junction temperature within safe limits.

Fig. 13 - Maximum output current vs. voltage ( $V_{CE}$ ) across each output transistor

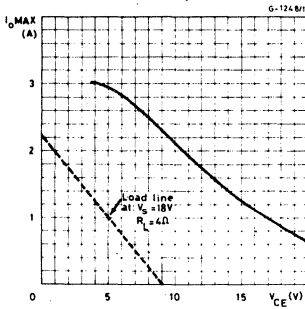
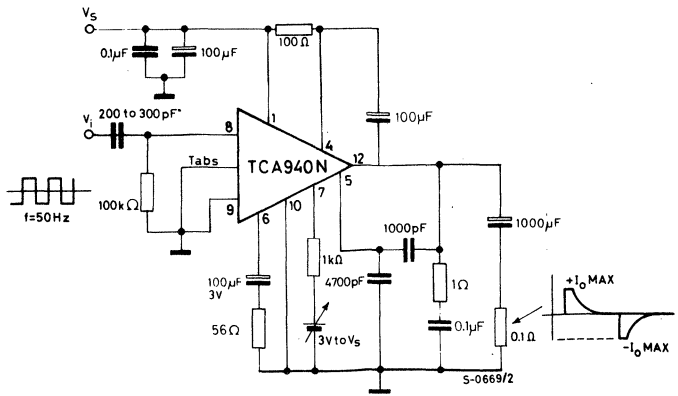


Fig. 14 - Test circuit for the limiting characteristics

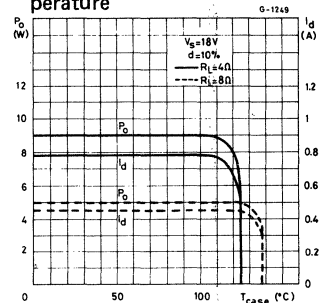


## THERMAL SHUT-DOWN

The presence of a thermal limiting circuit offers the following advantages:

- 1) an overload on the output (even if it is permanent), or an above-limit ambient temperature can be easily supported.
- 2) the heatsink can have a smaller factor of safety compared with that of a conventional circuit. There is no device damage in the case of too high a junction temperature: all that happens is that  $P_O$  (and therefore  $P_{tot}$ ) and  $I_d$  are reduced (fig. 15).

Fig. 15 - Output power and drain current vs. case temperature



## MOUNTING INSTRUCTION

The power dissipated in the circuit may be removed by connecting the tabs to an external heatsink according to fig. 16. The desired thermal resistance may be obtained by fixing the TCA 940N to a suitably dimensioned plate as shown in fig. 17. This plate can also act as a support for the whole printed circuit board; the mechanical stresses do not damage the integrated circuit. During soldering the tabs temperature must not exceed 260°C and the soldering time must not be longer than 12 seconds.

Fig. 16 - Maximum allowable power dissipation vs. ambient temperature

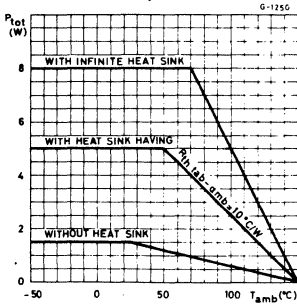


Fig. 17 - Mounting example

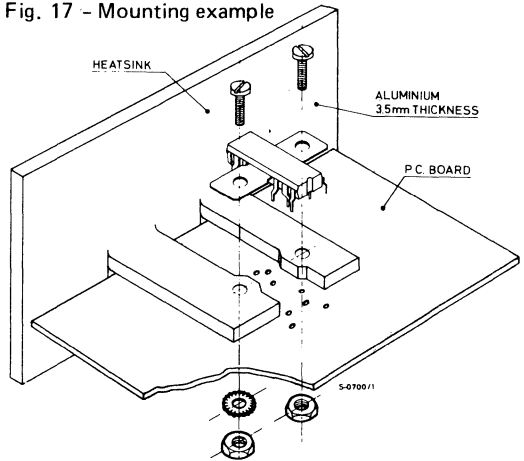


Fig. 18 - P.C. board and components layout of the test and application circuit (1:1 Scale).

